

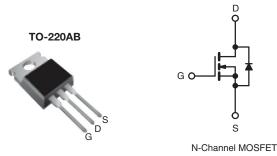
Vishay Siliconix

RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.028				
Q _g (Max.) (nC)	67				
Q _{gs} (nC)	18				
Q _{gd} (nC)	25				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ44PbF
	SiHFZ44-E3
SnPb	IRFZ44
	SiHFZ44

ABSOLUTE MAXIMUM RATINGS (T _C =	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	60	V
Gate-Source Voltage			V _{GS}	± 20	v
Continuous Drain Current ^e	V at 10 V	T _C = 25 °C		50	
Continuous Drain Current	V_{GS} at 10 V $T_C = 100 \degree C$		ID	36	А
Pulsed Drain Current ^a			I _{DM}	200	
Linear Derating Factor				1.0	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ
Maximum Power Dissipation	T _C =	25 °C	PD	150	W
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C
Soldering Recommendations (Peak Temperature) ^d	for 10 s			300	
Mauritian Tanana	6-32 or M3 screw			10	lbf ∙ in
Mounting Torque				1.1	N·m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 44 µH, R_g = 25 Ω , I_{AS} = 51 A (see fig. 12).

c. $I_{SD} \le 51$ A, dl/dt ≤ 250 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

e. Current limited by the package, (die current = 51 A).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATION PARAMETER	SYMBOL	TYP	,	MAX.			LINIT		
	_	-	•	62		UNIT			
Maximum Junction-to-Ambient	R _{thJA}			-	-		°C/W		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.00							
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.0							
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	vise noted)							
PARAMETER	SYMBOL	1	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static							<u> </u>	<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} -	= 0 V, I _D = 2	50 μA	60	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C,		-	0.060	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}		= V _{GS} , I _D = 2		2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20$ V	V	-	-	± 100	nA	
Zaro Gata Voltago Droin Current	I-	V _{DS}	= 60 V, V _{GS}	= 0 V	-	-	25		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V	, V _{GS} = 0 V,	T _J = 125 °C	-	-	250	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D	= 31 A ^b	-	-	0.028	Ω	
Forward Transconductance	g fs	V _{DS}	= 25 V, I _D =	31 A	15	-	-	S	
Dynamic									
Input Capacitance	C _{iss}	V _{GS} = 0 V,			-	1900	-		
Output Capacitance	C _{oss}]	$V_{DS} = 25 V,$		-	920	-	pF	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5			-	170	-	1	
Total Gate Charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13^{b}		-	-	67	nC		
Gate-Source Charge	Q _{gs}			-	-	18			
Gate-Drain Charge	Q _{gd}		see lig. 0 and 15		-	-	25	1	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 30 V, I _D = 51 A,		-	14	-			
Rise Time	t _r			-	110	-			
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega$,	$R_D = 0.55 \Omega$, see fig. 10 ^b	-	45	-	ns	
Fall Time	t _f	-			-	92	-		
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	Between lead,		-	4.5	-		
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	nH		
Drain-Source Body Diode Characteristic	s				•		•		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50	A		
Pulsed Diode Forward Current ^a	I _{SM}			-	-	200			
Body Diode Voltage	V_{SD}	T _J = 25 °C	C, I _S = 51 A,	$V_{GS} = 0 V^{b}$	-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/μs		-	120	180	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.53	0.80	nC		
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time i	s negligible (turn	-on is dor	ninated b	vleand	1-2)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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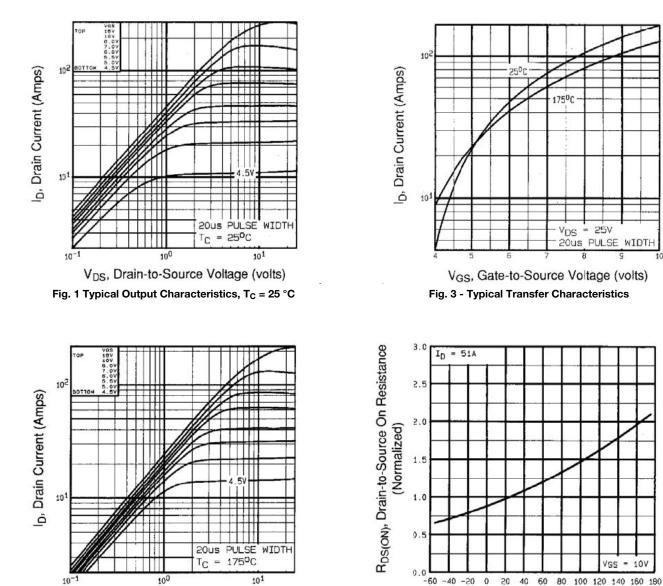
17500

VDS

25V

20us PULSE WIDTH

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

V_{DS}, Drain-to-Source Voltage (volts) Fig. 2 - Typical Output Characteristics, T_C = 175 °C

Fig. 4 - Normalized On-Resistance vs. Temperature

T_J, Junction Temperature (°C)

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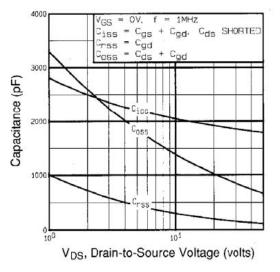


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

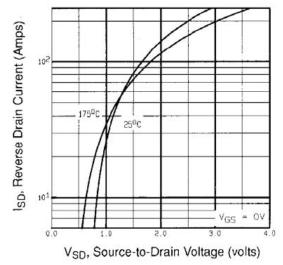


Fig. 7 - Typical Source-Drain Diode Forward Voltage

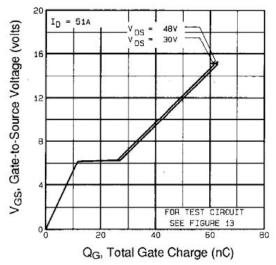
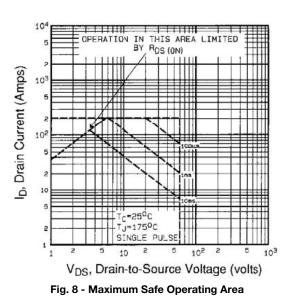


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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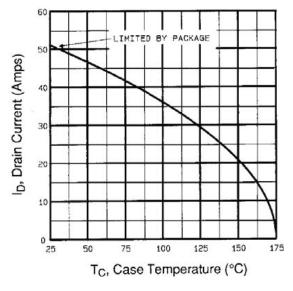


Fig. 9 - Maximum Drain Current vs. Case Temperature

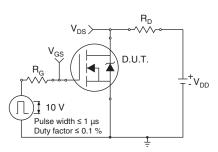


Fig. 10a - Switching Time Test Circuit

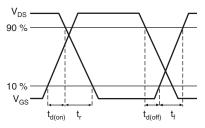
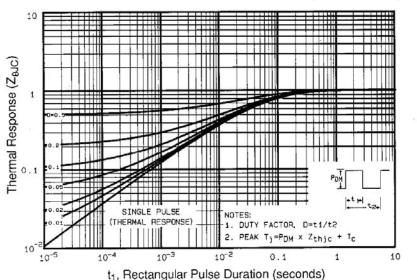


Fig. 10b - Switching Time Waveforms





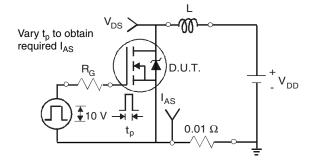
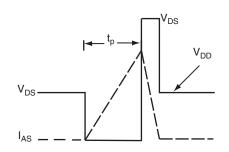
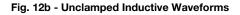


Fig. 12a - Unclamped Inductive Test Circuit





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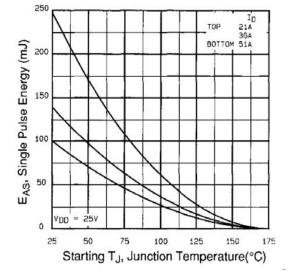


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

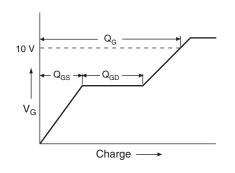


Fig. 13a - Basic Gate Charge Waveform

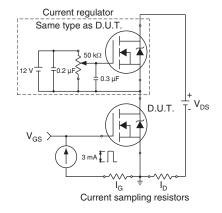


Fig. 13b - Gate Charge Test

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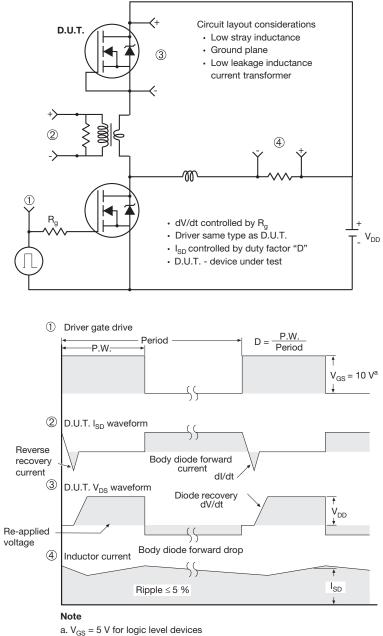


Fig. 14 - For N-Channel

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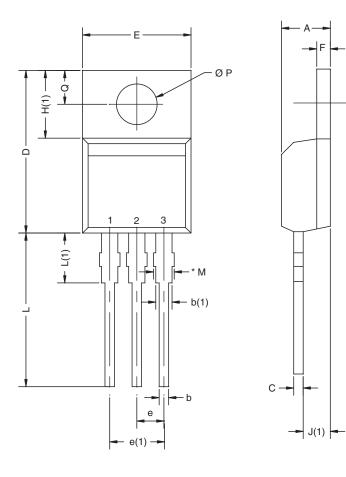
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Package Information

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TO-220AB



	MILLIMETERS		INC	CHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0416-Rev. M,		0.102	0.11	

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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